

## General Description

The AGM28P15C combines advanced trench MOSFET technology with a low resistance package to provide extremely low  $R_{DS(ON)}$ .

This device is ideal for load switch and battery protection applications.

## Features

- Advance high cell density Trench technology
- Low  $R_{DS(ON)}$  to minimize conductive loss
- Low Gate Charge for fast switching
- Low Thermal resistance
- 100% Avalanche tested
- 100% DVDS tested

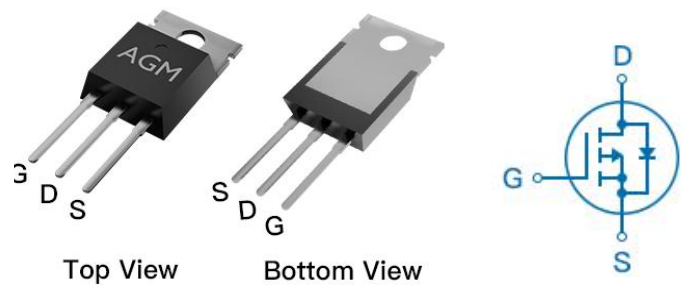
## Application

- MB/VGA Vcore
- SMPS 2<sup>nd</sup> Synchronous Rectifier
- POL application
- BLDC Motor driver

## Product Summary

BVDSS	RDSON	ID
-150V	78mΩ	-30A

## TO-220 Pin Configuration



## Package Marking and Ordering Information

Device Marking	Device	Device Package	Reel Size	Tape width	Quantity
AGM28P15C	AGM28P15C	TO-220	---	---	1000

**Table 1. Absolute Maximum Ratings (TC=25°C)**

Symbol	Parameter	Value	Unit
VDS	Drain-Source Voltage (VGS=0V)	-150	V
VGS	Gate-Source Voltage (VDS=0V)	±20	V
ID	Drain Current-Continuous(Tc=25°C) (Note 1)	-30	A
	Drain Current-Continuous(Tc=100°C)	-21.2	A
IDM (pluse)	Drain Current-Pulsed (Note 2)	-120	A
PD	Maximum Power Dissipation(Tc=25°C)	180	w
	Maximum Power Dissipation(Tc=100°C)	90	w
EAS	Avalanche energy (Note 3)	338	mJ
TJ,TSTG	Operating Junction and Storage Temperature Range	-55 To 175	°C

**Table 2. Thermal Characteristic**

Symbol	Parameter	Typ	Max	Unit
RθJA	Thermal Resistance Junction-ambient (Steady State) <sup>1</sup>	---	62.5	°C/W
RθJC	Thermal Resistance Junction-Case <sup>1</sup>	---	0.83	°C/W

**Table 3. Electrical Characteristics (TJ=25°C unless otherwise noted)**

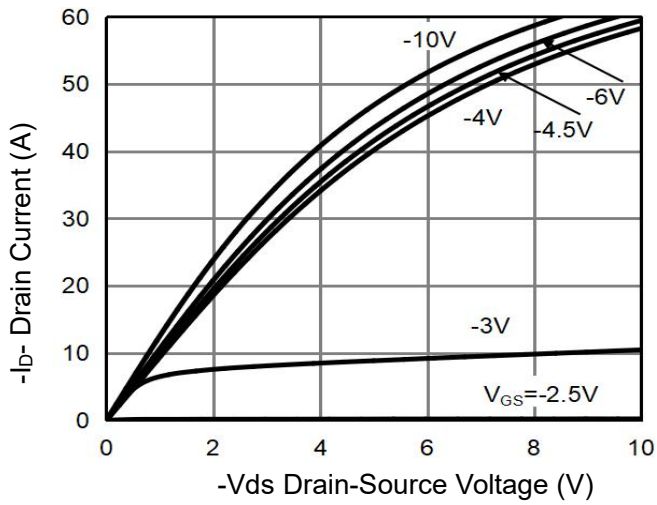
Symbol	Parameter	Conditions	Min	Typ	Max	Unit
On/Off States						
BVDSS	Drain-Source Breakdown Voltage	VGS=0V ID=-250μA	-150	--	--	V
IDSS	Zero Gate Voltage Drain Current	VDS=-150V,VGS=0V	--	--	1	μA
IGSS	Gate-Body Leakage Current	VGS=±20V,VDS=0V	--	--	±100	nA
VGS(th)	Gate Threshold Voltage	VDS=VGS,ID=-250μA	-1.2	--	-2.2	V
gFS	Forward Transconductance	VDS=-10V,ID=-20A	--	50	--	S
RDS(on)	Drain-Source On-State Resistance	VGS=-10V, ID=-20A	--	78	88	mΩ
		VGS=-4.5V, ID=-20A	--	81	95	mΩ
Dynamic Characteristics						
Ciss	Input Capacitance	VDS=-75V,VGS=0V, F=1MHZ	--	8240	--	pF
Coss	Output Capacitance		--	182	--	pF
Crss	Reverse Transfer Capacitance		--	115	--	pF
Rg	Gate resistance	VGS=0V, VDS=0V,f=1.0MHz	--	--	--	Ω
Switching Times						
td(on)	Turn-on Delay Time	VGS=-10V,VDS=-75V, ID=-20A,RGEN=9.1Ω	--	17	--	nS
tr	Turn-on Rise Time		--	80	--	nS
td(off)	Turn-Off Delay Time		--	44	--	nS
tf	Turn-Off Fall Time		--	65	--	nS
Qg	Total Gate Charge	VGS=-10V, VDS=-75V, ID=-20A	--	123	--	nC
Qgs	Gate-Source Charge		--	20	--	nC
Qgd	Gate-Drain Charge		--	27	--	nC
Source-Drain Diode Characteristics						
ISD	Source-Drain Current(Body Diode)		--	--	-30	A
VSD	Forward on Voltage	VGS=0V,IS=-20A	--	--	-1.2	V
trr	Reverse Recovery Time	IF=-20A , dI/dt=100A/μs , TJ=25℃	--	90	--	ns
Qrr	Reverse Recovery Charge		--	145	--	nc

Notes 1.The maximum current rating is package limited.

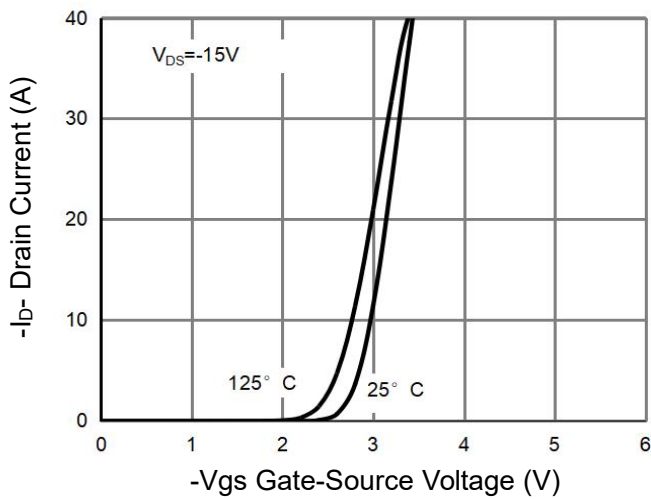
Notes 2.Repetitive Rating: Pulse width limited by maximum junction temperature.

Notes 3.EAS condition: TJ=25°C

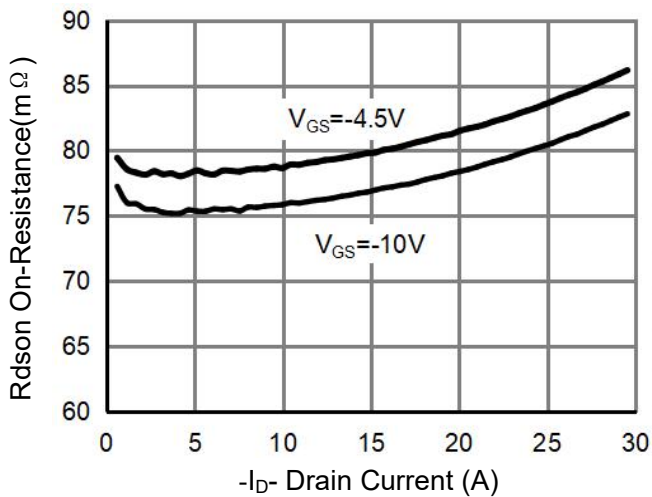
## Typical Electrical and Thermal Characteristics (Curves)



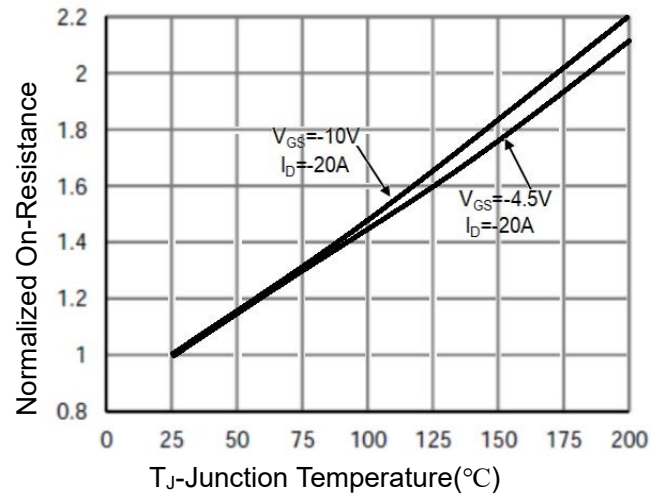
**Figure 1 Output Characteristics**



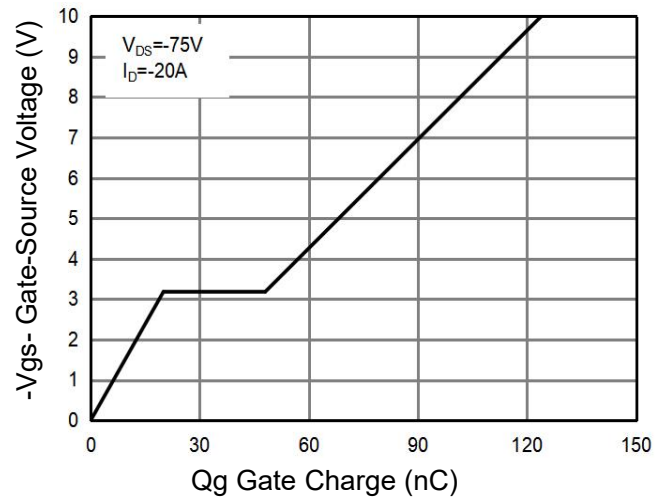
**Figure 2 Transfer Characteristics**



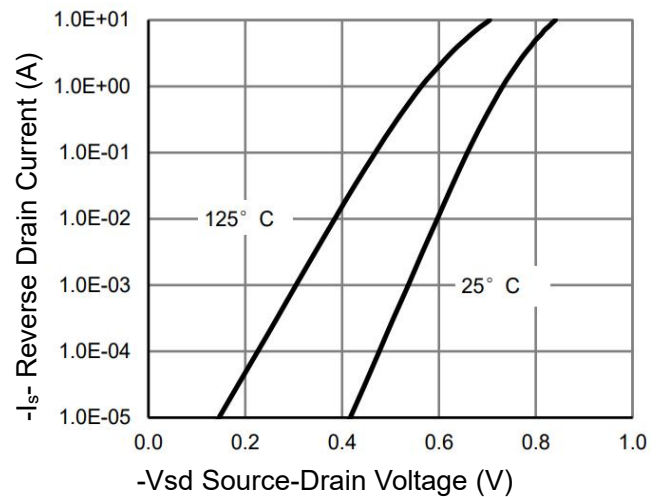
**Figure 3 Rdson- Drain Current**



**Figure 4 Rdson-Junction Temperature**



**Figure 5 Gate Charge**



**Figure 6 Source- Drain Diode Forward**

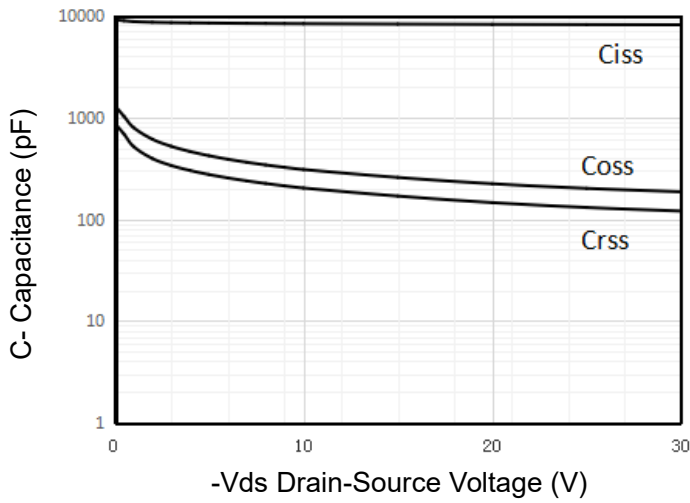


Figure 7 Capacitance vs Vds

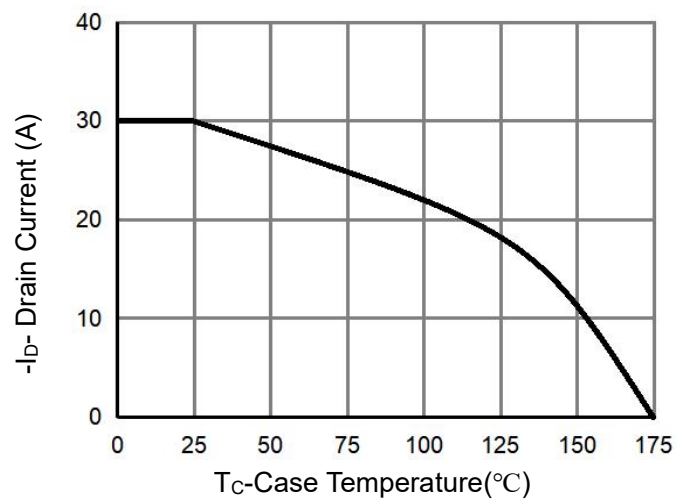


Figure 9 Drain Current vs Case Temperature

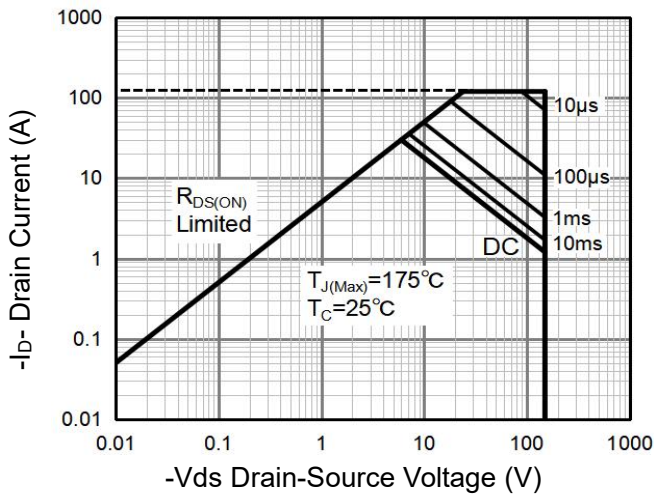


Figure 8 Safe Operation Area

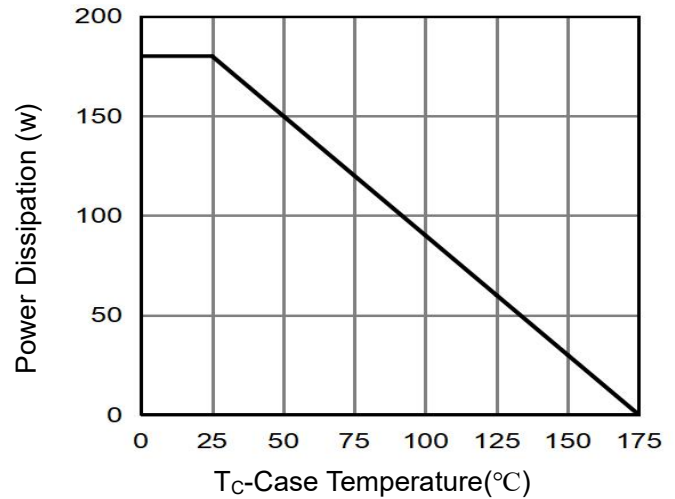


Figure 10 Power De-rating

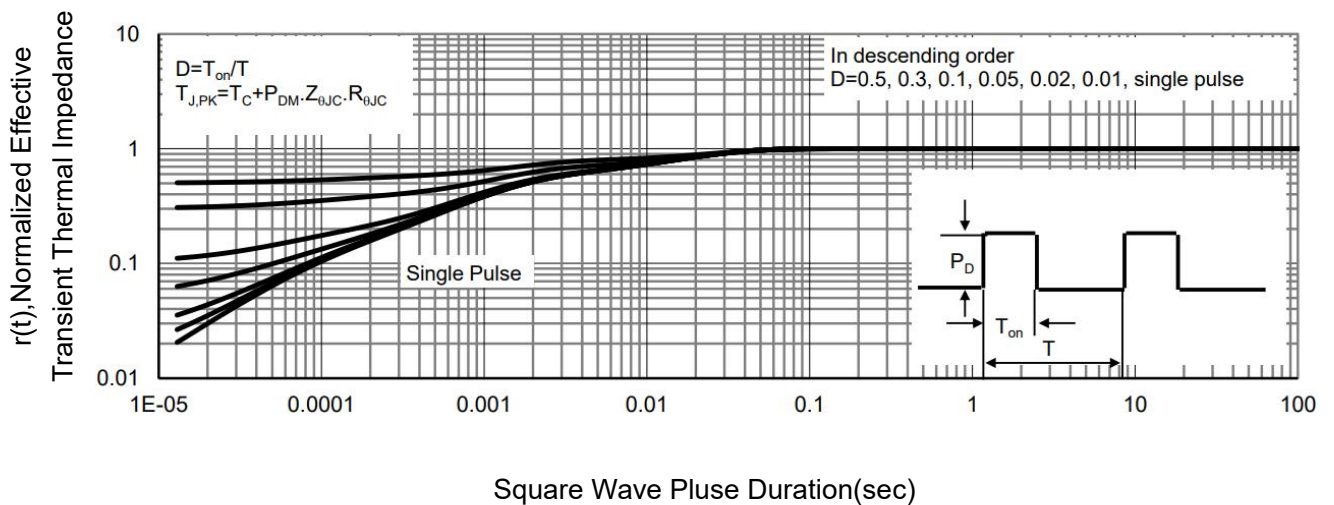
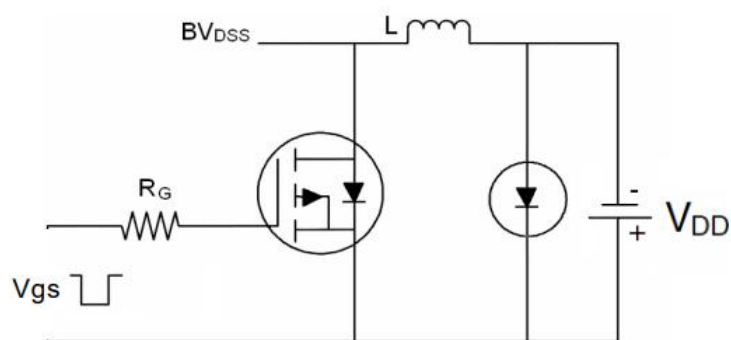


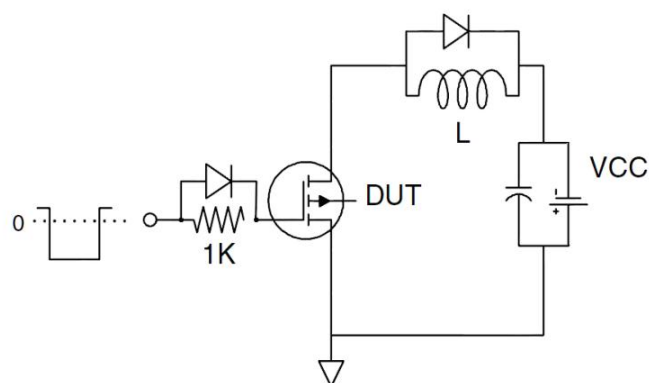
Figure 11 Normalized Maximum Transient Thermal Impedance

## Test Circuit

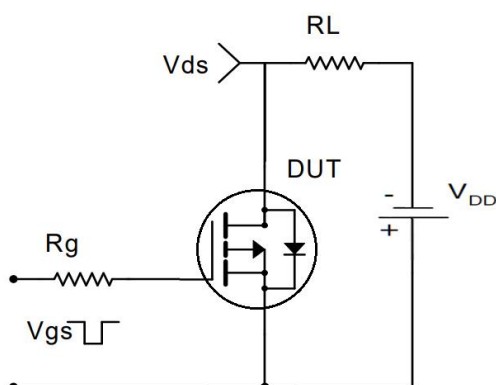
### 1) $E_{AS}$ test Circuit



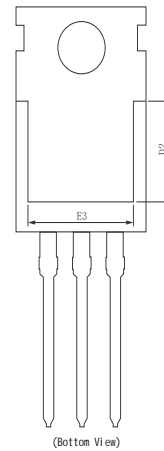
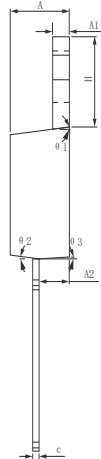
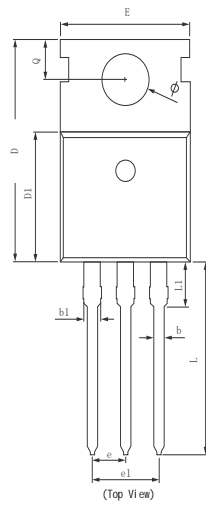
### 2) Gate charge test Circuit



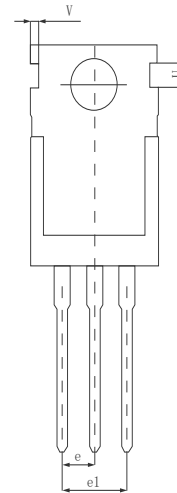
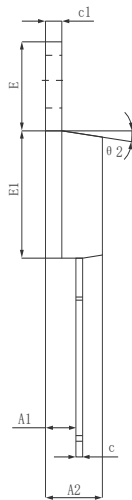
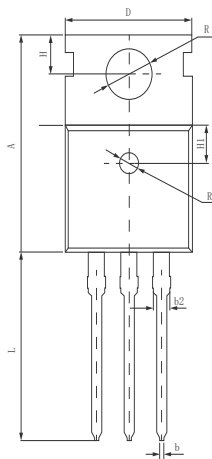
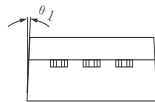
### 3) Switch Time Test Circuit



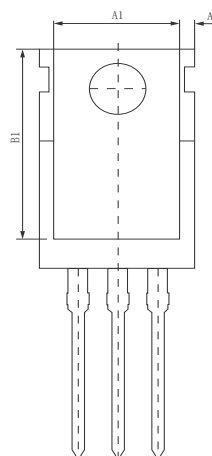
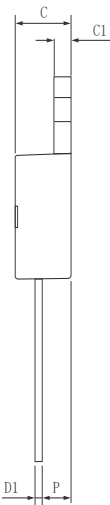
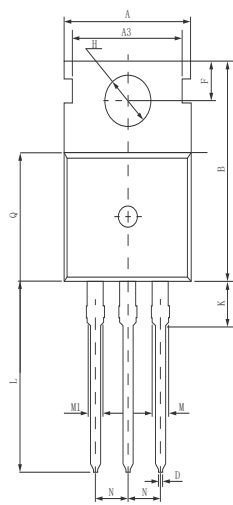
# Dimensions (TO-220)



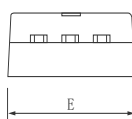
SYMBOL	MILLIMETER		
	MIN	Typ.	MAX
A	4.370	4.570	4.700
A1	1.250	1.300	1.400
A2	2.150	2.350	2.550
b	0.700	0.800	0.950
b1	1.170	1.270	1.470
c	0.450	0.500	0.600
D	15.100	15.600	16.100
D1	8.800	9.100	9.400
D2	5.500	6.300 REF	
E	9.700	10.000	10.300
E3	7.000	7.600 REF	
e	2.540 BSC		
e1	5.080 BSC		
L	13.200	13.500	13.800
L1		3.100	3.400
H	6.250	6.500	1.352
Φ	3.400	3.600	3.800
Q	2.600	2.800	3.000
θ 1	7° TYP		
θ 2	7° TYP		
θ 3	3° TYP		



SYMBOL	MILLIMETER		
	MIN	Typ.	MAX
A	15.400	15.600	15.800
A1	2.350	2.400	2.500
A2	4.400	4.500	4.700
b	0.700	0.800	0.900
b2	1.180	1.310	1.440
c	0.480	0.500	0.560
c1	1.290	1.300	1.320
D	9.800	10.000	10.200
E	6.400	6.500	6.600
E1	9.000	9.100	9.200
e	2.420	2.540	2.660
e1	4.840	5.080	5.320
H	2.730	2.800	2.870
H1	2.400	2.500	2.600
L	13.020	13.370	13.720
R	3.500	3.600	3.730
R1	1.400	1.500	1.600
U	1.650	1.750	1.850
V	0.580	0.680	0.780
θ 1	2°	2.5°	3°
θ 2	6.5°	7°	7.5°



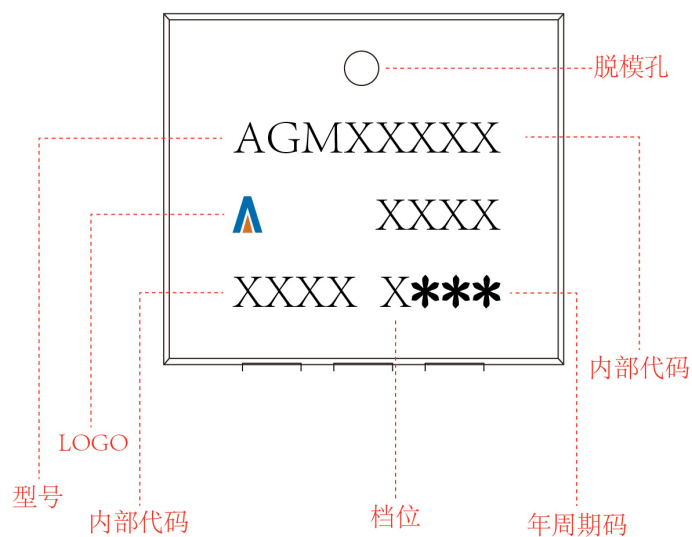
Symbol	Dimensions (mm)
A	10.0±0.3
A1	8.0±0.2
A2	0.94±0.1
A3	8.7±0.1
B	15.6±0.4
B1	13.2±0.2
C	4.5±0.2
C1	1.3±0.2
D	0.8±0.2
D1	0.5±0.1
E	10.0±0.3
F	2.8±0.1
H	3.6±0.1
K	3.1±0.2
L	1.3±0.4
M	1.38±0.1
M1	1.28±0.1
N	2.54 (typ)
P	2.4±0.3
Q	9.15±0.25



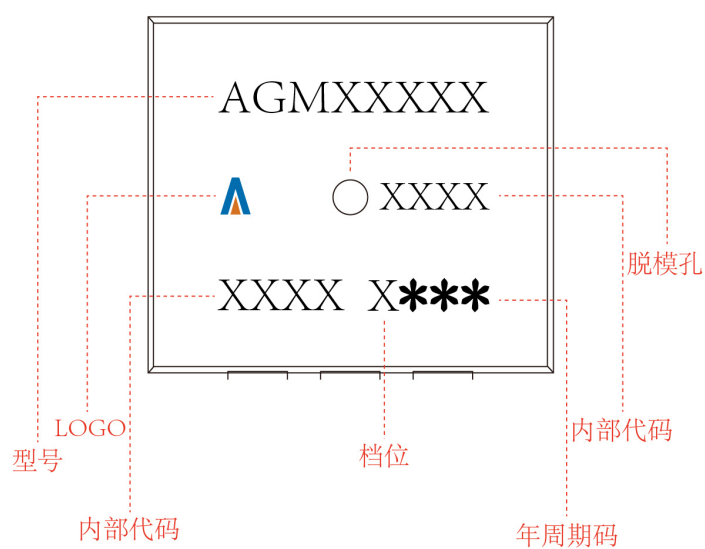
# TO-220

## Marking Instructions:

### Model1:



### Model2:




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